

Device Features

- Operated at 5.0V
- 33.0dBm Output IP3 at 0dBm/tone at 3600MHz
- 21.5dB Gain at 3600MHz
- 20.3dBm P1dB at 3600MHz
- 0.69dB NF at 3600MHz
- Fast shut down to support TDD systems
- Lead-free/Green/RoHS Compliant DFN8 2x2 Package

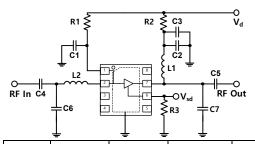
Product Description

BeRex's BLB28 is a high Gain LNA, based on GaAs E-pHEMT process and packaged in a RoHS-compliant DFN 8L 2x2mm² Surface mount package. It is designed for use where low noise and high Gain are required and features low noise and high OIP3 at Frequency range of 2.5~7.0GHz. It is fast enable switching speed for TDD-5G application. All devices are 100% RF/DC tested and classified as HBM ESD Class 1C.

Applications

- Base station Infrastructure
- Commercial/Industrial/Military wireless system
- TDD or FDD LTE system/5G NR

Applications Circuit



| BOM | 2.65GHz | 3.6GHz | 4.9GHz | 5.8GHz |
|----------|---------|---------|-----------|-----------|
| C1 | N/A | N/A | N/A | N/A |
| C2,C4,C5 | 100pF | 100pF | 100pF | 100pF |
| C3 | 1nF | 1nF | 1nF | 1nF |
| C6 | 1pF | 0.5pF | 0.5pF(HQ) | 0.5pF(HQ) |
| C7 | N/A | N/A | 0.3pF | 0.3pF |
| R1 | 1.5Kohm | 1.5Kohm | 1.5Kohm | 1.5Kohm |
| R2 | 0ohm | 0ohm | 0ohm | 0ohm |
| R3 | 20kohm | 20kohm | 20kohm | 20kohm |
| L1 | 2.7nH | 2.7nH | 2.7nH | 2.7nH |
| L2 | 1.5nH | LINE | LINE | LINE |

Part Marking (XX:Wafer number)



Electrical Specifications

Device performance $_$ measured on a BeRex evaluation board at 25°C, V_d =5V, 50 Ω system.

| Parameter | Conditions | Min | Тур | Max | Unit |
|--------------------------------|-------------------------------------|------|-------|------|------|
| Operational Frequency Range | | 2500 | | 7000 | MHz |
| Test Frequency | | | 4900 | | MHz |
| Gain | | 19.2 | 20.7 | | dB |
| Input Return Loss | | | -10.0 | | dB |
| Output Return Loss | | | -10.5 | | dB |
| Output IP3 | $0 dBm / tone$, Δf =1 MHz | 28.5 | 31.5 | | dBm |
| Output P1dB | | 18.6 | 19.6 | | dBm |
| 5G NR ACLR ¹ | | 8.0 | 9.0 | | dBm |
| Noise Figure ² | | | 0.8 | 1.0 | dB |

¹ ACLR Channel Power measured at -50dBc.

Recommended Operating Conditions¹

| Parameter | Min | Тур | Max | Unit |
|--|------|--------|------|-------|
| Bandwidth | 2500 | | 7000 | MHz |
| I _d @ (V _d = 5.0V) | 42 | 52 | 62 | mA |
| V_d | 3.3 | 5.0 | 5.25 | V |
| dG/dT | | -0.008 | | dB/°C |
| R _{TH} | | 62 | | °C/W |
| Operating Case Temperature | -40 | | +105 | °C |

Electrical specifications are measured at specified test conditions.

Specifications are not guaranteed over all recommended operating conditions.

Absolute Maximum Ratings

| Parameter | Rating | Unit |
|----------------------|-------------|------|
| Storage Temperature | -55 to +155 | °C |
| Junction Temperature | +150 | °C |
| Supply Voltage | +7 | V |
| Supply Current | 130 | mA |
| Input RF Power | 30 | dBm |

Operation of this device above any of these parameters may result in permanent damage.

^{- 5}G NR Downlink FR1: SCS 30KHz, CBW 100MHz, 256QAM, PAR 9.66 at 0.01% Prob.

² Noise Figure data has input trace loss de-embedded.



Recommended Operating Conditions²

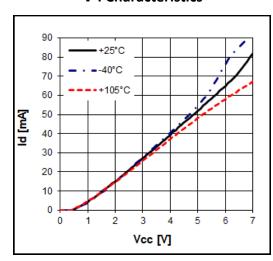
| Paramter | Condition | Min. | Typical | Max. | Unit |
|--------------------------|----------------------------|------|---------|-------|------|
| Chutdau Cantual | On state | 0 | | 0.9 | V |
| Shutdown Control | Off state(shutdown) | 1.17 | | V_d | V |
| Current, I _d | On state 5V | 42 | 52 | 62 | mA |
| | Off state(shutdown) | 5 | 7 | 9 | mA |
| Shutdown pin current,Isd | $1.17V \le V_{sd} < V_{D}$ | | 200 | | uA |
| Switching Time | Rise time(10% to 90%) | | 150 | | ns |
| | Fall time(90% to 10%) | | 50 | | ns |

Typical Performance (V_d=5.0V, I_d=52mA, T=25°C)

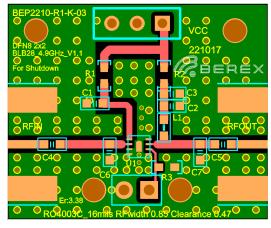
| Parameter | | Frequency | | | | |
|---------------------------|-------|-----------|-------|------|-----|--|
| $V_d = 5V$ | 2650 | 3600 | 4900 | 5800 | MHz | |
| Gain | 23.9 | 21.5 | 20.7 | 20.8 | dB | |
| S11 | -11.8 | -11.0 | -10.0 | -9.6 | dB | |
| S22 | -11.6 | -10.0 | -10.5 | -7.3 | dB | |
| OIP3 ¹ | 32.1 | 33.0 | 31.5 | 29.8 | dBm | |
| P1dB | 19.0 | 20.3 | 19.6 | 18.3 | dBm | |
| 5G NR ACLR ² | 7.5 | 9.0 | 8.2 | 6.2 | dBm | |
| Noise Figure ³ | 0.67 | 0.69 | 0.80 | 1.00 | dB | |

 $^{^1\,\}text{OIP3}$ measured on two tones with a output power $\,$ 0 dBm/tone , $\Delta f\text{=}1\,\text{MHz}$

V-I Characteristics



Evaluation Board



*Dielectric constant _ 4.2 *RF pattern width 24mil *16mil thick RO4003 PCB

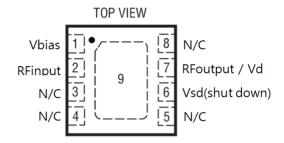
 $^{^{2}}$ ACLR Channel Power measured at -50dBc.

 $^{{\}hspace{-0.07cm}\hbox{-}\hspace{-0.07cm}}$ 5G NR Downlink FR1 : SCS 30KHz, CBW 100MHz, 256QAM, PAR 9.66 at 0.01% Prob.

 $^{^{\}rm 3}$ Noise Figure data has input trace loss de-embedded.

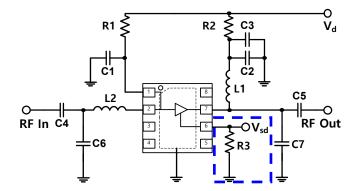


Pin Configuration and Description



 $\begin{array}{c} {\sf DC\ PACKAGE} \\ {\sf 8-LEAD\ (2mm\times2mm)\ PLASTIC\ DFN} \end{array}$

| Pin No. | Name | Description |
|---------|-----------------|---|
| 1 | Vbias | Vbias sets Idq through external resistor for V_d =5V or V_d =3.3V. |
| 2 | RFinput | RFinput pin. A DC Block with High Q performance is required. |
| 6 | Vsd(shut down) | Power on/off control pin. $1.17V \le V_{sd}$ disables device. If function is not desired, may be connected to ground. |
| 7 | RFoutput / Vd | RFoutput / V_d pin. Supply Vd through choke/Inductor for the device. |
| 3,4,5,8 | NC | No internal connection to die. May be connected to ground. |
| 9 | Backside Paddle | Exposed Pad is RF/DC ground, must be soldered to PCB. |

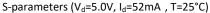


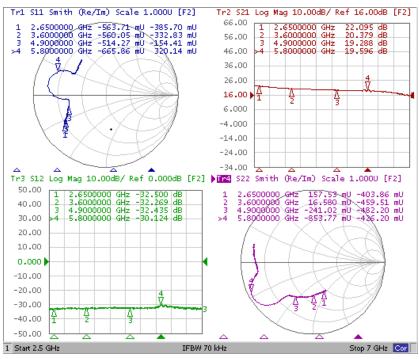
Vsd(shut down) App note.

- 1. shut down Applications: R3 = $20K\Omega$
- 2. R3 are optional and do not need to be loaded if the shut-down functionality is not needed; If R3 are not loaded, the LNA will operate in its standard "ON" state.



Typical Device Data





S-Parameter

 $(V_d=5.0V,I_d=52mA, T=25$ °C, calibrated to device leads)

| Freq | S11 | S11 | S21 | S21 | S12 | S12 | S22 | S22 |
|-------|------|---------|-------|--------|------|-------|------|---------|
| [MHz] | Mag | Ang | Mag | Ang | Mag | Ang | Mag | Ang |
| 2500 | 0.68 | -143.05 | 13.24 | 66.62 | 0.02 | 16.78 | 0.43 | -65.81 |
| 2800 | 0.69 | -144.90 | 12.19 | 58.84 | 0.02 | 19.10 | 0.44 | -71.44 |
| 3100 | 0.68 | -146.46 | 11.34 | 51.11 | 0.02 | 14.75 | 0.44 | -78.01 |
| 3400 | 0.67 | -147.17 | 10.52 | 45.23 | 0.02 | 11.34 | 0.45 | -83.11 |
| 3700 | 0.66 | -146.88 | 10.09 | 38.14 | 0.02 | 12.11 | 0.46 | -89.19 |
| 4000 | 0.64 | -147.26 | 9.69 | 31.59 | 0.02 | 13.76 | 0.48 | -95.21 |
| 4300 | 0.62 | -148.03 | 9.49 | 24.03 | 0.02 | 14.09 | 0.50 | -102.27 |
| 4600 | 0.59 | -150.76 | 9.25 | 16.97 | 0.03 | 8.70 | 0.51 | -108.98 |
| 4900 | 0.55 | -155.08 | 9.13 | 8.65 | 0.02 | 13.82 | 0.54 | -116.86 |
| 5200 | 0.52 | -160.80 | 8.95 | -0.27 | 0.03 | 10.59 | 0.57 | -125.52 |
| 5500 | 0.55 | -164.68 | 8.97 | -9.06 | 0.02 | 10.01 | 0.63 | -131.82 |
| 5800 | 0.64 | 155.46 | 8.40 | -25.55 | 0.03 | 13.14 | 0.94 | -146.95 |
| 6100 | 0.51 | 149.50 | 8.53 | -34.56 | 0.03 | 0.35 | 0.79 | -171.64 |
| 6400 | 0.53 | 141.24 | 7.83 | -48.59 | 0.02 | -0.14 | 0.79 | 179.55 |
| 6700 | 0.57 | 134.44 | 6.71 | -62.73 | 0.02 | -0.43 | 0.82 | 170.86 |
| 7000 | 0.62 | 129.74 | 5.67 | -72.35 | 0.02 | 5.22 | 0.85 | 162.91 |

BeRex ●website: <u>www.berex.com</u> ●email: <u>sales@berex.com</u>

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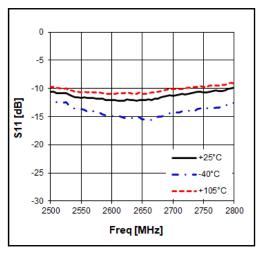


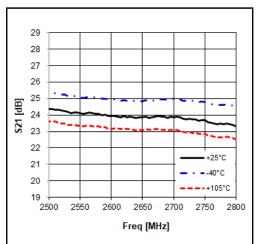
| Application Circuit: 2650 MHz | App | lication | Circuit: | 2650 | MHz |
|-------------------------------|-----|----------|-----------------|------|-----|
|-------------------------------|-----|----------|-----------------|------|-----|

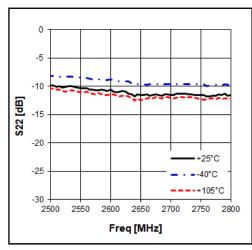
| Schematic Diagram | ВС | M | size | Marks |
|---|----------|---------|------|--------------------------|
| | C1 | N/A | 1608 | |
| R1 > R2 > C3 V4 | C2,C4,C5 | 100pF | 1608 | |
| $\begin{array}{c ccccccccccccccccccccccccccccccccccc$ | С3 | 1nF | 1608 | |
| C1 | C6 | 1pF | 1608 | Distance to pin2 : 4.0mm |
| L1 C5 | L1 | 2.7nH | 1608 | |
| RF In C4 | L2 | 1.5nH | 1608 | Distance to pin2 : 1.0mm |
| +c6 | R1 | 1.5Kohm | 1608 | |
| ļ | R2 | 0ohm | 1608 | |
| | R3 | 20kohm | 1608 | |

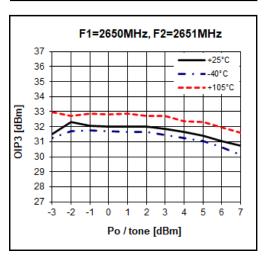
Typical Performance

 $V_d = 5V, I_d = 52mA$



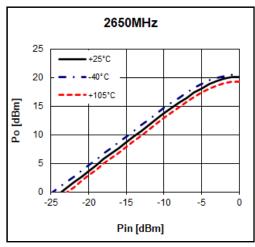


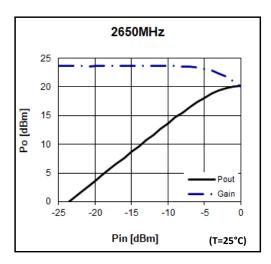


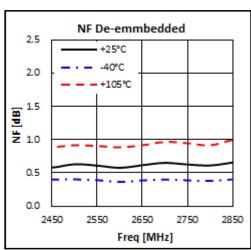


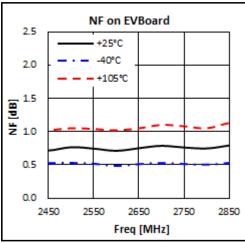


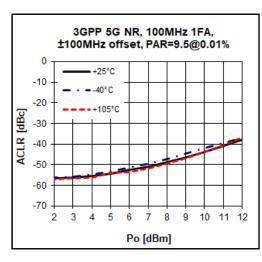


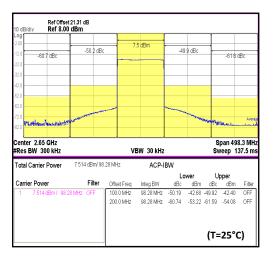










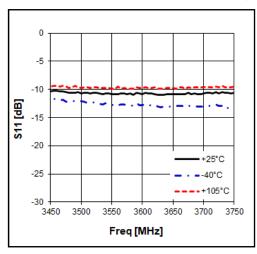


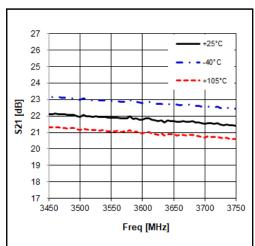


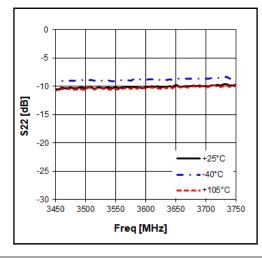
| Application | Circuit: | 3600 | MHz |
|-------------|----------|------|-----|
| | | | |

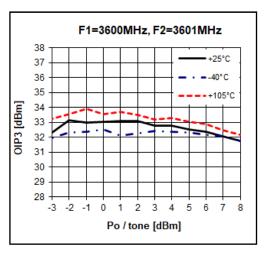
| Schematic Diagram | ВС | M | size | Marks |
|--|----------|---------|------|--------------------------|
| | C1 | N/A | 1608 | |
| R1 \$ R2 \$ C3 V _d | C2,C4,C5 | 100pF | 1608 | |
| KI S KZ S Vd | C3 | 1nF | 1608 | |
| | C6 | 0.5pF | 1608 | Distance to pin2 : 5.5mm |
| - \\ \{\bar{\bar{\bar{\bar{\bar{\bar{\ba | L1 | 2.7nH | 1608 | |
| RF In C4 | R1 | 1.5Kohm | 1608 | |
| +c6 | R2 | 0ohm | 1608 | |
| ļ | R3 | 20kohm | 1608 | |
| | | | | |

Typical Performance



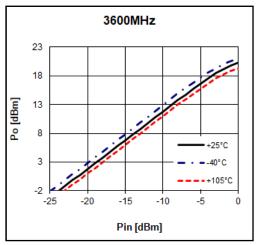


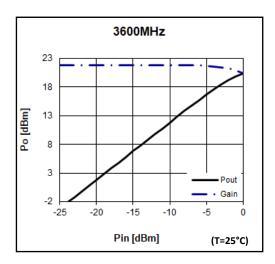


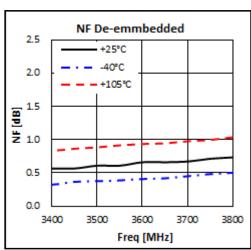


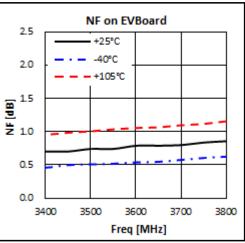


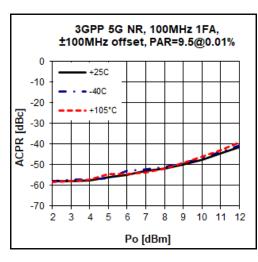


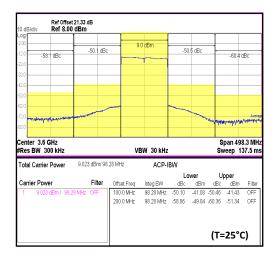












Marks



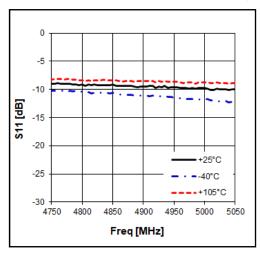
2500 - 7000 MHz High Gain LNA

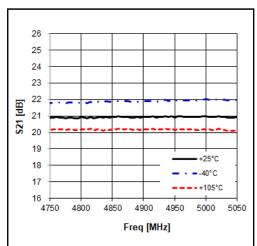
| Application (| Circuit: 490 | 0 MHz | | |
|----------------------|--------------|-------|------|---------|
| Schematic Diagram | ВС | M | size | |
| | C1 | N/A | 1608 | |
| D | C2,C4,C5 | 100pF | 1608 | |
| $R1$ $R2$ $C3$ V_d | C3 | 1nF | 1608 | |
| C1 { C2 | C6(HQ) | 0.5pF | 1608 | Distanc |

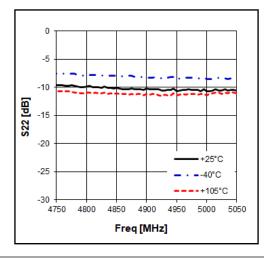
| R1 ≶ R2 ≶ C3 V _d | C2,C4,C5 |
|--------------------------------------|----------|
| R1 ₹ R2 ₹ C3 V _d | C3 |
| { c ₂ _ | C6(HQ) |
| - L1 C5 | C7 |
| RF In C4 3 5 OV _{sd} RF Out | L1 |
| +c6 | R1 |
| | R2 |
| | DΩ |

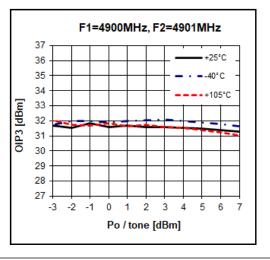
| C2,C4,C5 | 100pF | 1608 | |
|----------|---------|------|--------------------------|
| С3 | 1nF | 1608 | |
| C6(HQ) | 0.5pF | 1608 | Distance to pin2 : 1.5mm |
| C7 | 0.3pF | 1608 | Distance to pin7 : 4.5mm |
| L1 | 2.7nH | 1608 | |
| R1 | 1.5Kohm | 1608 | |
| R2 | 0ohm | 1608 | |
| R3 | 20kohm | 1608 | |

Typical Performance



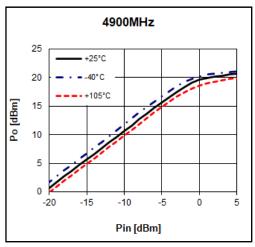


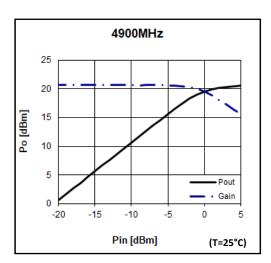


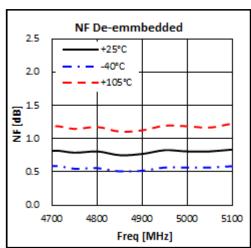


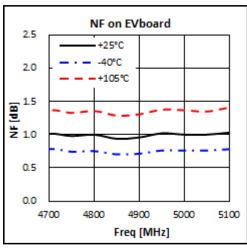


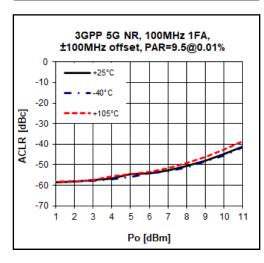


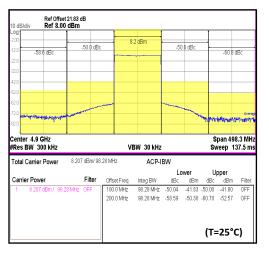










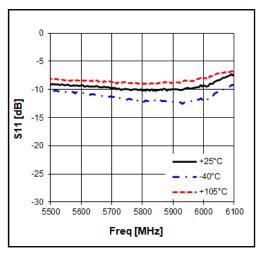


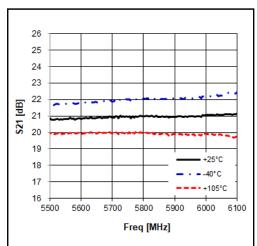


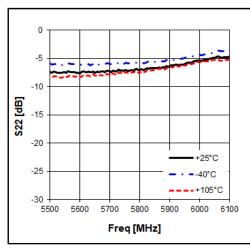
| App | lication | Circuit: | 5800 | MHz |
|-----|----------|-----------------|------|-----|
|-----|----------|-----------------|------|-----|

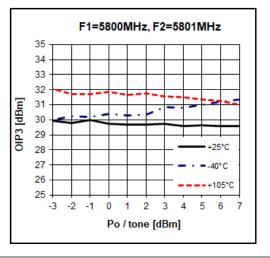
| Schematic Diagram | ВС | M | size | Marks |
|-------------------------------|----------|---------|------|--------------------------|
| | C1 | N/A | 1608 | |
| R1 \$ R2 \$ C3 V _d | C2,C4,C5 | 100pF | 1608 | |
| R1 \$ R2 \$ C3 V _d | C3 | 1nF | 1608 | |
| | C6(HQ) | 0.5pF | 1608 | Distance to pin2 : 0.8mm |
| C5 | C7 | 0.3pF | 1608 | Distance to pin7 : 3.0mm |
| RF In C4 Proving RF Out | L1 | 2.7nH | 1608 | |
| +c6 | R1 | 1.5Kohm | 1608 | |
| | R2 | 0ohm | 1608 | |
| | R3 | 20kohm | 1608 | |

Typical Performance



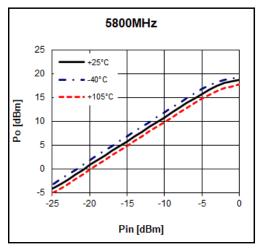


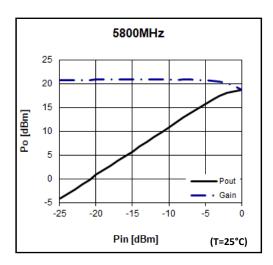


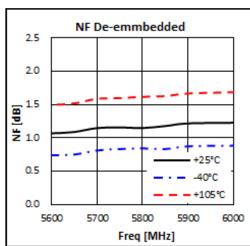


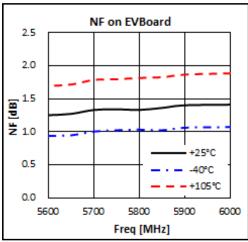


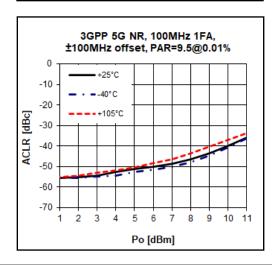


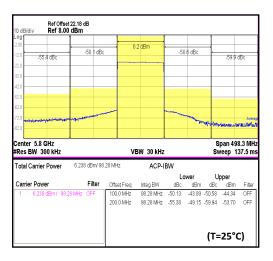






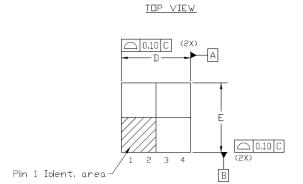


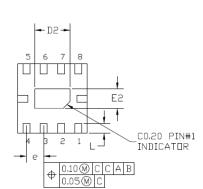




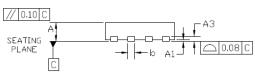


Package Outline Dimension





BOTTOM VIEW



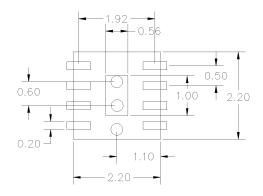
SIDE VIEW

- 1. DIMENSION AND TOLERANCING CONFORM TO ASME Y14.5M-1994.
- 2. CONTROLLING DIMENSIONS : MILLIMETER, CONVERTED INCH DIMENSION ARE NOT NECESSARILY EXACT.

| S Y | | | CDM | IM□N | | |
|-------------|--------|-----------|--------|-------|----------|-------|
| M B D | DIMENS | IONS MILL | IMETER | DI | MENSIONS | INCH |
| Ľ | MIN. | N□M. | MAX. | MIN. | N□M. | MAX. |
| Α | 0.50 | 0.55 | 0.60 | 0.020 | 0.022 | 0.024 |
| АЗ | | 0.150 RE | F | (| 0.006 RE | F |
| A1 | 0.00 | 0.02 | 0.05 | 0.000 | 0.001 | 0.002 |
| b | 0.15 | 0.20 | 0.25 | 0.006 | 0.008 | 0.010 |
| D | 1.90 | 2,00 | 2.10 | 0.075 | 0.079 | 0.083 |
| D2 | 0.92 | 1.02 | 1.12 | 0.036 | 0.040 | 0.044 |
| E | 1.90 | 2.00 | 2.10 | 0.075 | 0.079 | 0.083 |
| E2 | 0.46 | 0,56 | 0.66 | 0.018 | 0,022 | 0.026 |
| е | | 0.50 BSC | | C | 1050 B20 | C |
| L | 0.24 | 0.29 | 0.30 | 0.010 | 0.011 | 0.012 |

Suggested PCB Land Pattern and PAD Layout

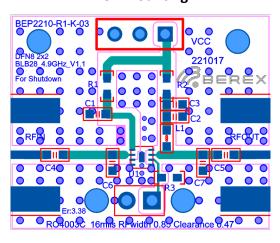
PCB Land Pattern



Note: All dimension _ millimeters

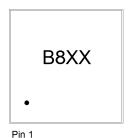
PCB lay out _ on BeRex website

PCB Mounting





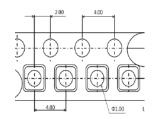
Package Marking



Tape & Reel

DFN 8L 2x2

Packaging information:



Tape Width (mm): 8

Reel Size (inches): 7

Device Cavity Pitch (mm): 4

Devices Per Reel: 3000

Lead plating finish

XX = Wafer No.

100% Tin Matte finish

(All BeRex products undergoes a 1 hour, 150 degree C, Anneal bake to eliminate thin whisker growth concerns.)

MSL / ESD Rating

ESD Rating: Class 1C

Value: Passes \geq 1000V to < 2000 V

Test: Human Body Model (HBM)

Standard: ANSI/ESDA/JS-001-2017

Caution: ESD Sensitive
Appropriate precautions in handling, packaging
and testing devices must be observed.

MSL Rating:

Level 1 at +260°C convection reflow

Proper ESD procedures should be followed when handling this device.

Standard: JEDEC Standard J-STD-020

RoHS Compliance

This part is compliant with Restrictions on the Use of Certain Hazardous Substances in Electrical and Electronic Equipment (RoHS) Directive 2011/65/EU as amended by Directive 2015/863/EU. This product also is compliant with a concentration of the Substances of Very High Concern (SVHC) candidate list which are contained in a quantity of less than 0.1%(w/w) in each components of a product and/or its packaging placed on the European Community market by the BeRex and Suppliers.

NATO CAGE code:

| 2 N 9 6 F |
|-------------------|
|-------------------|